# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6119703

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
BRIAN HOFFMAN	03/26/2020
CORY RICHARD BOUDREAU	04/04/2020
TODD ETHAN BRUNNER	04/06/2020
DAVID C. FRANCHINO	04/04/2020
ALEXANDRA KAY HARTFORD	05/12/2020
VIVIAN LIN	04/15/2020
MOHAN MAHADEVAN	03/27/2020
JOHN GAETANO MATRECANO	03/26/2020
ALEXANDRA SURASKY-YSASI	04/22/2020
TIMOTHY ALAN TALDA	03/26/2020

## **RECEIVING PARTY DATA**

Name:	AMAZON TECHNOLOGIES, INC.
Street Address:	PO BOX 81226
City:	SEATTLE
State/Country:	WASHINGTON
Postal Code:	98108-1226

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16881562

## **CORRESPONDENCE DATA**

**Fax Number:** (206)430-5115

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Address Line 4: MOUNT VERNON, WASHINGTON 98273

ATTORNEY DOCKET NUMBER: 110.0792-US-CON1

NAME OF SUBMITTER:	RICHARD TWILLEY
SIGNATURE:	/Richard Twilley/
DATE SIGNED:	05/22/2020
	This document serves as an Oath/Declaration (37 CFR 1.63).

#### **Total Attachments: 13**

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source=2020-05-22 P43640-US02CON 110.0792-US-CON1 Fully Executed Combined Assignment and Declaration from Parent#page2.tif

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source=2020-05-22 P43640-US02CON 110.0792-US-CON1 Fully Executed Combined Assignment and Declaration from Parent#page13.tif

This Assignment and Declaration copy is intended for the U.S. Continuation Application being filed via EFS-Web on May 22, 2020, attorney docket no. 110.0792-US-CON1.

## PATENT ASSIGNMENT AND DECLARATION (37 CFR 1.63)

**VIVIAN LIN** 

410 Terry Avenue North

Seattle, WA 98109-5210

MOHAN MAHADEVAN

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JOHN GAETANO MATRECANO

**ALEXANDRA SURASKY-YSASI** 

U.S. Patent Appln. No. <u>15/925,676</u>

Filing Date March 19, 2018

Attorney Docket No. <u>110.0792-US</u>

Client Docket No. P43640-US

## **PARTIES TO THE ASSIGNMENT**

Assignor(s):

**BRIAN HOFFMAN** 

410 Terry Avenue North Seattle, WA 98109-5210

CORY RICHARD BOUDREAU

410 Terry Avenue North Seattle, WA 98109-5210

**TODD ETHAN BRUNNER** 

410 Terry Avenue North Seattle, WA 98109-5210

DAVID C. FRANCHINO

410 Terry Avenue North Seattle, WA 98109-5210

**ALEXANDRA KAY HARTFORD** 

410 Terry Avenue North Seattle, WA 98109-5210

Assignee:

Amazon Technologies, Inc. PO Box 81226 Seattle, WA 98108-1226

**AGREEMENT** 

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled

"RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS" (Invention) for which a non-provisional application for United States Letters Patent (Application):

$\boxtimes$	was filed on	March 19,	<u>2018</u> and	d accorded	U.S.	Application	No.	<u>15/925,6</u>	<u>576</u> ; or

will be filed concurrently with the submission of this executed PATENT ASSIGNMENT for recordation.

U.S. Patent Appln. No. 15/925,676

Attorney Docket No. 110.0792-US

Filing Date March 19, 2018

Client Docket No. P43640-US

Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS

Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi;

**Timothy Alan Talda** 

ASSIGNOR(S) hereby authorizes and requests ASSIGNEE'S legal representatives, of

Athorus, PLLC, associated with Customer No. 136715, to insert in the header above and here in

parentheses (U.S. Patent Application No. 15/925,676, filed March 19, 2018) this application's U.S.

application number and filing date, when known.

WHEREAS, ASSIGNEE, a corporation of the State of Nevada, is desirous of acquiring the entire

right, title and interest in and to the Invention and in and to any letters patent that may be granted

therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is

hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and

assigns, the entire right, title and interest in and to said Invention and any improvements thereto, said

Application and any and all letters patent which may be granted for said Invention in the United States

of America and its territorial possessions and in any and all foreign countries, and in any and all

provisional, divisions, reissues, re-examinations and continuations thereof, including the right to file

foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said

Application to which said foreign applications are entitled by virtue of international convention, treaty

or otherwise, said Invention, Application and all letters patent on said Invention to be held and enjoyed

by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns

as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this

assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the

Commissioner of Patents and Trademarks, as well as all other applicable patent offices throughout the

Page 2 of 13

U.S. Patent Appln. No. 15/925,676

Attorney Docket No. 110.0792-US

Filing Date March 19, 2018

Client Docket No. P43640-US

Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS

Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi;

Timothy Alan Talda

world, to issue all letters patent on said Invention to ASSIGNEE. ASSIGNOR(S) agree to execute all

instruments and documents required for the making and prosecution of applications for United States

and foreign letters patent on said Invention, for litigation regarding said letters patent, or for the

purpose of protecting title to said Invention or letters patent therefor.

AND ASSIGNOR(S) DOES HEREBY sell, assign, transfer, and convey to ASSIGNEE, its successors,

legal representatives, and assigns all claims for damages and all remedies arising out of any violation of

the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may

accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past

infringements of said letters patent before or after issuance.

AND ASSIGNOR(S) DOES HEREBY covenant and agree that ASSIGNOR(S) will communicate to

ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting the

Invention or said Application, and testify in any legal proceeding, assist in the preparation of any other

patent property relating to the Application and the Invention or any improvements made thereto,

sign/execute all lawful papers, provide all requested documents, execute and make all rightful oaths

and/or declarations in connection with the Application and the Invention including any improvements

made thereto, any patent applications filed therefrom, and any continuing application filed from any of

the aforementioned applications, and generally do everything possible to aid ASSIGNEE, its successors,

legal representatives and assigns, to obtain and enforce proper patent protection for the Invention in all

countries. These provisions are binding upon ASSIGNOR's heirs, legal representatives, administrators,

and assigns.

Page 3 of 13

U.S. Patent Appln. No. 15/925,676 Attorney Docket No. 110.0792-US Filing Date March 19, 2018 Client Docket No. P43640-US Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; **Timothy Alan Talda DECLARATION** As a below named inventor, I hereby declare that: This declaration is directed to: the attached application; or United States Patent Application number 15/925,676 filed on March 19, 2018; or PCT international application number \_\_\_\_\_\_ filed on \_\_\_\_\_. The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application. I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

Docusigned by:

/Brian Hoffman/
7393F5977CE24D5...

BRIAN HOFFMAN

March 26, 2020

Date

Page 4 of 13

Attorney Docket No. 110.0792-US U.S. Patent Appln. No. 15/925,676 Client Docket No. P43640-US Filing Date March 19, 2018 Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; Timothy Alan Talda DECLARATION As a below named inventor, I hereby declare that: This declaration is directed to: the attached application; or United States Patent Application number 15/925,676 filed on March 19, 2018; or PCT international application number \_\_\_\_\_\_\_ filed on \_\_\_\_\_\_. The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application. I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

Coka kidwako roodkevo

U.S. Patent Appln. No. <u>15/925,676</u> Attorney Docket No. 110.0792-US Filing Date March 19, 2018 Client Docket No. P43640-US Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; **Timothy Alan Talda DECLARATION** As a below named inventor, I hereby declare that: This declaration is directed to: the attached application; or United States Patent Application number 15/925,676 filed on March 19, 2018; or PCT international application number \_\_\_\_\_\_ filed on \_\_\_\_\_. The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application. I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both. Todd Brunner **TODD ETHAN BRUNNER** 

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04/06/2020

U.S. Patent Appln. No. <u>15/925,676</u> Attorney Docket No. <u>110.0792-US</u>

Filing Date March 19, 2018

Client Docket No. <u>P43640-US</u>

Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS

Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; Timothy Alan Talda

DECLARATION
As a below named inventor, I hereby declare that:
This declaration is directed to:
the attached application; or
United States Patent Application number 15/925,676 filed on March 19, 2018; or
PCT international application numberfiled on
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application.
I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 1 USC 1001 by fine or imprisonment of not more than five (5) years, or both.
DAVID C. FRANČHINO

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4/4/2020

U.S. Patent Appln. No. <u>15/925,676</u>

Attorney Docket No. 110.0792-US

Filing Date March 19, 2018

Client Docket No. P43640-US

Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS

Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; Timothy Alan Talda

Page 8 of 13

U.S. Patent Appln. No. <u>15/925,676</u> Attorney Docket No. 110.0792-US Filing Date March 19, 2018 Client Docket No. P43640-US Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; Timothy Alan Talda **DECLARATION** As a below named inventor, I hereby declare that: This declaration is directed to: the attached application; or United States Patent Application number 15/925,676 filed on March 19, 2018; or PCT international application number \_\_\_\_\_\_\_ filed on \_\_\_\_\_\_. The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application. I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both. VIVIAN LIN 04/15/2020

> PATENT REEL: 052735 FRAME: 0027

Date

4852-5086-7039, v. 1

U.S. Patent Appln. No. <u>15/925,676</u> Attorney Docket No. 110.0792-US Filing Date March 19, 2018 Client Docket No. P43640-US Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; **Timothy Alan Talda DECLARATION** As a below named inventor, I hereby declare that: This declaration is directed to: the attached application; or United States Patent Application number 15/925,676 filed on March 19, 2018; or PCT international application number \_\_\_\_\_\_ filed on \_\_\_\_\_. The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application. I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56.

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Mohan Mahadevan/

1100DAA63F004C3...

MOHAN MAHADEVAN

March 27, 2020

Date

Page 10 of 13

U.S. Patent Appln. No. <u>15/925,676</u> Attorney Docket No. 110.0792-US Filing Date March 19, 2018 Client Docket No. P43640-US Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS Inventors: Brian Hoffman; Cory Richard Boudreau; Todd Ethan Brunner; David C. Franchino; Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; **Timothy Alan Talda DECLARATION** As a below named inventor, I hereby declare that: This declaration is directed to: the attached application; or United States Patent Application number 15/925,676 filed on March 19, 2018; or PCT international application number \_\_\_\_\_\_ filed on \_\_\_\_\_. The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed Invention in the application. I have reviewed and understand the contents of the above-identified application, and acknowledge the duty to disclose to the US Patent & Trademark Office all information known to me to be material to the patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both. DocuSigned by: John Gaetano Matrecano/ JOHN GAETANO MATRECANO

Page 11 of 13

PATENT REEL: 052735 FRAME: 0029

March 26, 2020

U.S. Patent Appin. No. <u>15/925,676</u>

Attorney Docket No. 110.0792-05

Filing Date March 19, 2018

DECLARATION

Client Docket No. P43640-US

Title of the invention: RIGHT SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS

Inventors: Brian Hoffman, Cory Richard Boudreau: Todd Ethan Brunner; David C. Franchino, Alexandra Kay Hartford; Vivian Lin; Mohan Mahadevan; John Gaetano Matrecano; Alexandra Surasky-Ysasi; Timothy Alan Talda

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ALEXANDRA SURASKY-YSASI

4/24/202

Date

Fage 12 of 18

U.S. Patent Appln. No. <u>15/925,676</u> Attorney Docket No. 110.0792-US Filing Date March 19, 2018 Client Docket No. P43640-US Title of the Invention: RIGHT-SIZED THERMOFORMED CAVITIES FOR PACKAGING ITEMS

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USC 1001 by fine or imprisonment of not more than five (5) years, or both.
Timothy Alan Taldar  38347AB818594C1
March 26, 2020
Date

Page 13 of 13

**RECORDED: 05/22/2020** 

4852-5086-7039, v. 1